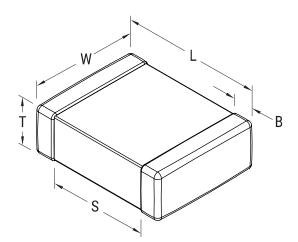


C1206X222K2RACTU

Aliases (C1206X222K2RAC7800) SMD Comm X7R Flex, Ceramic, 2,200 pF, 10%, 200 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 1206, 1.5 mm



Click here for the 3D model.

General Information		
Series	SMD Comm X7R Flex	
Style	SMD Chip	
Description	SMD, MLCC, FT-CAP, Temperature Stable	
Features	FT-CAP, Temperature Stable	
RoHS	Yes	
Termination	Flexible Termination	
Marking	No	
AEC-Q200	No	
Typical Component Weight	17 mg	
Shelf Life	78 Weeks	
MSL	1	

Dimensions		Specifica
Chip Size	1206	Capacita
L	3.3mm +/-0.4mm	Measure
W	1.6mm +/-0.35mm	Tolerance
т	0.78mm +/-0.20mm	Voltage [
S	1.5mm MIN	Dielectric
В	0.6mm +/-0.25mm	Tempera
		Temp. Co

Packaging Specifications

T&R, 180mm, Plastic Tape Packaging Packaging Quantity 4000

ations 2,200 pF ance 1 kHz 1.0Vrms ment Condition e 10% DC 200 VDC ic Withstanding Voltage 500 VDC -55/+125°C ature Range Coefficient X7R Capacitance Change with 15%, 1kHz 1.0Vrms Reference to +25°C and 0 VDC Applied (TCC) 2.5%1kHz1.0Vrms **Dissipation Factor** 3% Loss/Decade Hour: Referee Aging Rate Time is 1000 Hours Insulation Resistance 100 GOhms

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